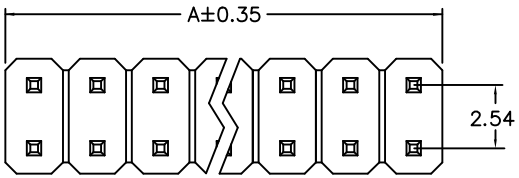
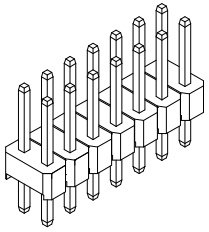
REV.	SPECIFICATION	ECN NO.	APPD.





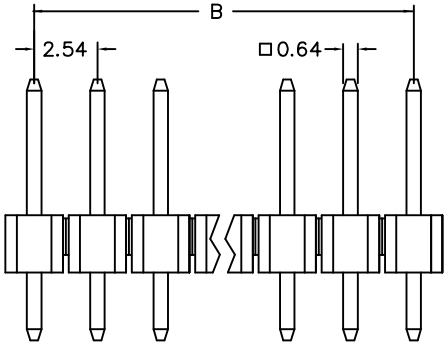
Material:

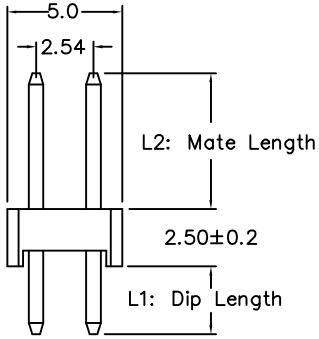
Housing: PBT, UL94V-0,Black.
Contacts: Brass, Gold Plated or 80~120u" Tin Plated over Nickel 50u".

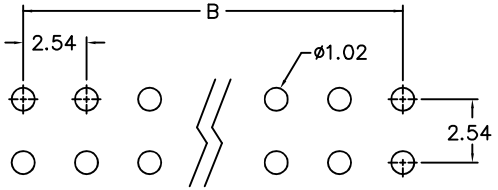
Electrical Characteristics:

Current Rating: 3 AMP.
Dielectric Withstanding Voltage: AC 1000V.
Insulator Resistance: 1000MΩ min.
Contact Resistance: 20mΩ max.
Operating Temperature: -40°C~+105°C.

***RoHS Compliant**







P.C. Board Layout

2011-	2	X	xx	G	00	S	B
Series	Double Row		No. of Pin Per Row	G: Gold Plated T: Tin Plated	00: Gold Flash 10: 10u" 15: 15u" 30: 30u" Blank: for Tin Plated	S: Straight	B: Bulk Package

Positions	2 Thru 80
A	2.54 X No. of Positions/2 −0.25
B	2.54 X No. of Positions/2 −2.54

Standard item:
ie: 2011-2XxxG00SB(Total 11.60mm Dip 3.0mm Mate 6.1mm)
Custom item:
ie: 2011-2XxxG00S-2.5-5.9B(2011-2XxxG00S-L1-L2B)
2.5mm Dip Length(increment of 0.10mm)
5.9mm Mate Length(increment of 0.10mm)

Tolerances	Dwg No.	2011D01004	Title:	2011 Series
x = ±0.5 .x = ±0.25 .xx = ±0.15	Projection			Pin Header 2.54mmX2.54mm Double Row Straight Solder Type
	Unit mm	Scale 1:1		
	Drawn By	Jerry 11/14'19	① 535	

OUPIIN ELECTRONIC(KUNSHAN) CO., LTD.

P/N:	2011−2XxxG00SB		
SHEET	1/1	Ver.No.	B4

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